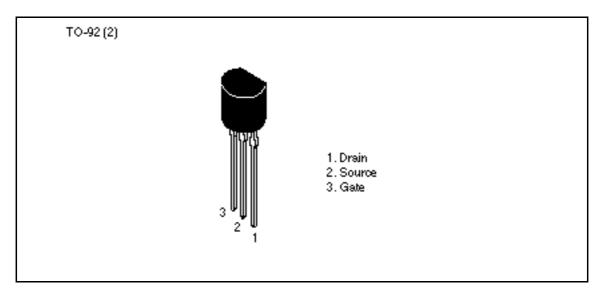
Silicon N-Channel Junction FET

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Application

Low frequency low noise amplifier

Outline



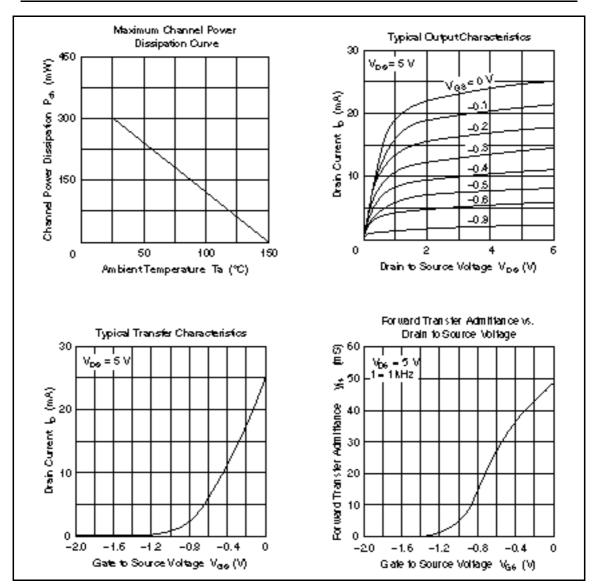


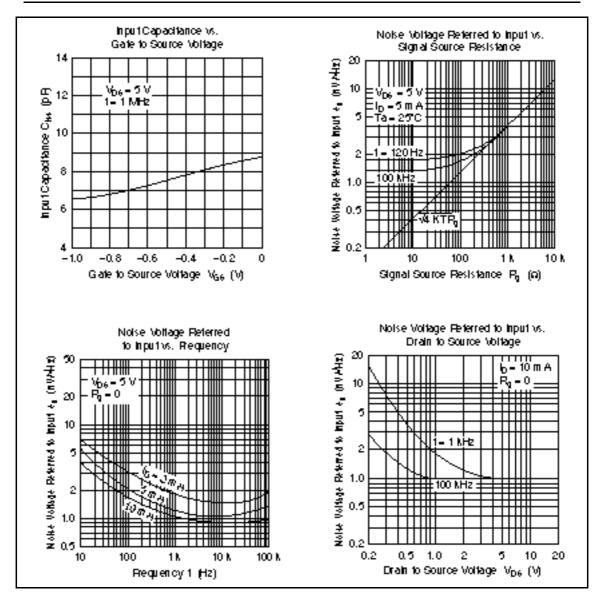
Absolute Maximum Ratings (Ta = 25° C)

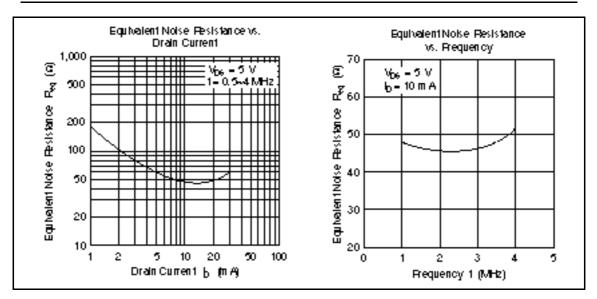
Item	Symbol	Ratings	Unit
Gate to drain voltage	V_{GDO}	–15	V
Gate to source voltage	V _{GSO}	-15	V
Drain current	I _D	50	mA
Gate current	l _G	5	mA
Channel power dissipation	Pch	300	mW
Channel temperature	Tch	150	°C
Storage temperature	Tstg	–55 to +150	°C

Electrical Characteristics (Ta = 25°C)

ltem		Symbol	Min	Тур	Max	Unit	Test conditions
Gate to dra voltage	in breakdown	$V_{(\text{BR})\text{GDO}}$	-15	_	_	V	I _G = -100 μA
Gate to sou voltage	irce breakdown	$V_{(\text{BR})\text{GSO}}$	-15	_	_	V	I _G = -100 μA
Gate cutoff	current	I _{GSS}			10	nA	$V_{GS} = -7 \text{ V}, \text{ V}_{DS} = 0$
Drain curre	nt	l_ss ^{*1}	5		50	mA	$V_{\rm DS} = 5 V, V_{\rm GS} = 0$
Gate to sou	rce cutoff voltage	$V_{\text{GS(off)}}$		—	-3.0	V	$V_{\rm DS}$ = 5 V, I _D = 100 µA
Forward tra	insfer admittance	y _{fs}	25	45	_	mS	V_{DS} = 5 V, V_{GS} = 0, f = 1 kHz
Input capao	citance	Ciss		8.5	_	pF	V_{DS} = 5 V, V_{GS} = 0, f = 1 MHz
Noise volta	ge referred to input	e _n		1.2	—	nV/ Hz	$V_{DS} = 5 V, I_{D} = 5 mA, Rg = 0,$ f = 100 kHz
Note: 1.	The 2SK291 is grou	uped by I _{DS}	s as follo	ows.			
Grade	P Q	!	R		S	т	
I _{DSS}	5 to 16 1	4 to 24	20 to	32	28 to 42	36 te	o 50







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